Quad 1-of-2 multiplexer/demultiplexer Rev. 5 — 11 November 2016

Product data sheet

General description 1.

The 74CBTLV3257 provides a quad 1-of-2 high-speed multiplexer/demultiplexer with common select (S) and output enable (OE) inputs. The low ON resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise. When pin \overline{OE} = LOW, one of the two switches is selected (low-impedance ON-state) with pin S. When pin \overline{OE} = HIGH, all switches are in the high-impedance OFF-state, independent of pin S.

Schmitt trigger action at control input makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 2.3 V to 3.6 V.

To ensure the high-impedance OFF-state during power-up or power-down, \overline{OE} should be tied to the V_{CC} through a pull-up resistor. The minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

- Supply voltage range from 2.3 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- 5 Ω switch connection between two ports
- Rail to rail switching on data I/O ports
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



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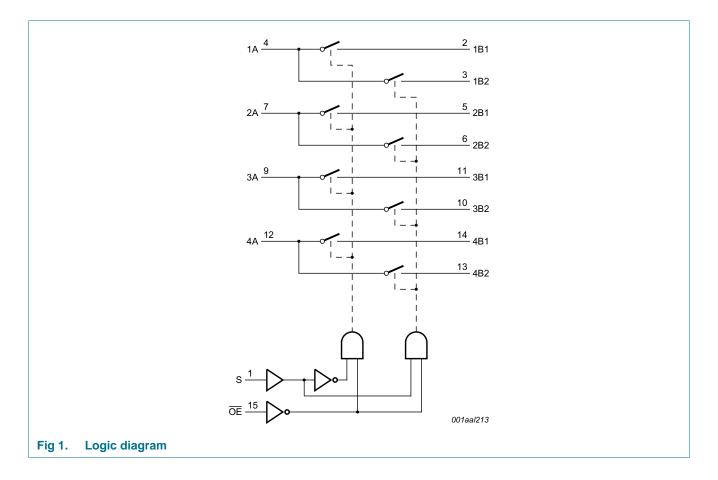
Ordering information 3.

Table 1.	Ordering i	information
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Type number	Package								
	Temperature range	Name	Description	Version					
74CBTLV3257D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74CBTLV3257DS	–40 °C to +125 °C	SSOP16 ^[1]	plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT519-1					
74CBTLV3257PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					
74CBTLV3257BQ	–40 °C to +125 °C	DHVQFN16	plastic dual-in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-1					

[1] Also known as QSOP16.

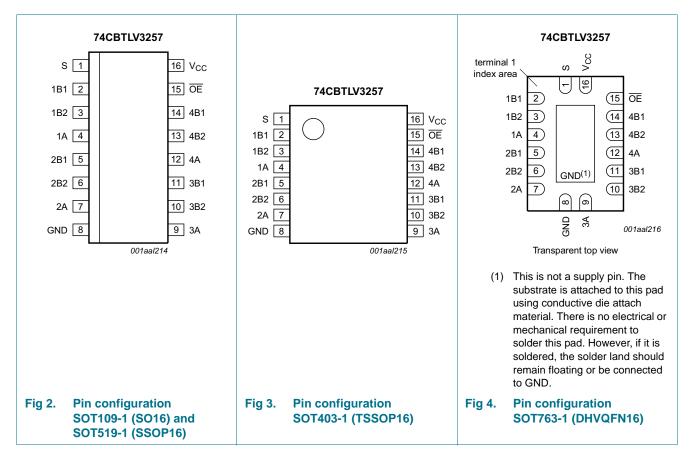
Functional diagram 4.



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Pinning information 5.

5.1 Pinning



5.2 Pin description

Table 2. Pin description								
Symbol	Pin	Description						
S	1	select input						
1B1 to 4B1	2, 5, 11, 14	B1 input/output						
1B2 to 4B2	3, 6, 10, 13	B2 input/output						
1A to 4A	4, 7, 9, 12	A input/output						
GND	8	ground (0 V)						
ŌĒ	15	output enable input (active LOW)						
V _{CC}	16	supply voltage						

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6. Functional description

Table	3.	Function	table ^[1]
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Inputs	Function switch	
ŌĒ	S	
L	L	nA = nB1
L	Н	nA = nB2
н	X	disconnect nA and nBn

[1] H = HIGH voltage level; L = LOW voltage level.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+4.6	V
VI	input voltage	control inputs	<u>[1]</u>	-0.5	+4.6	V
V _{SW}	switch voltage	enable and disable mode	[2]	-0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	V _I < -0.5 V		-50	-	mA
I _{SK}	switch clamping current	V _I < -0.5 V		-50	-	mA
I _{SW}	switch current	$V_{SW} = 0 V \text{ to } V_{CC}$		-	±128	mA
I _{CC}	supply current			-	+100	mA
I _{GND}	ground current			-100	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[3]	-	500	mW

[1] The minimum input voltage rating may be exceeded if the input clamping current ratings are observed.

[2] The switch voltage ratings may be exceeded if switch clamping current ratings are observed

[3] For SSOP16 and TSSOP16 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C. For DHVQFN16 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

8. Recommended operating conditions

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			2.3	3.6	V
VI	input voltage			0	3.6	V
V _{SW}	switch voltage	enable and disable mode		0	V _{CC}	V
T _{amb}	ambient temperature			-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CC} = 2.3 V to 3.6 V	<u>[1]</u>	0	200	ns/V

[1] Applies to control signal levels.

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9. Static characteristics

Table 6. Static characteristics

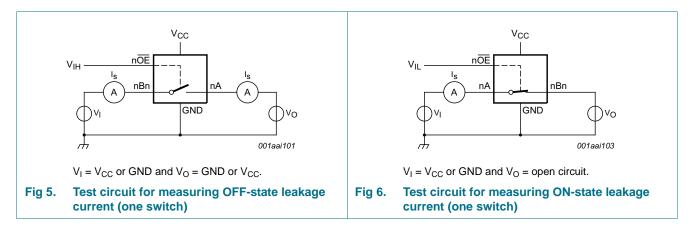
At recommended operating conditions voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T _{amb} =	–40 °C to -	⊦85 °C	T _{amb} = -40 °C to +125 °C		
			Min	Typ <mark>[1]</mark>	Max	Min	Max	-
V _{IH}	HIGH-level	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	V
	input voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level input	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	V
	voltage	V _{CC} = 3.0 V to 3.6 V	-	-	0.9	-	0.9	V
l _l	input leakage current	pin \overline{OE} , S; V _I = GND to V _{CC} ; V _{CC} = 3.6 V	-	-	±1	-	±20	μA
I _{S(OFF)}	OFF-state leakage current	$V_{CC} = 3.6 \text{ V}; \text{ see } \frac{\text{Figure 5}}{1000 \text{ Figure 5}}$	-	-	±1	-	±20	μA
I _{S(ON)}	ON-state leakage current	$V_{CC} = 3.6 \text{ V}; \text{ see } \frac{\text{Figure } 6}{1000 \text{ G}}$	-	-	±1	-	±20	μA
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V}$	-	-	±10	-	±50	μΑ
I _{CC}	supply current		-	-	10	-	50	μA
ΔI _{CC}	additional supply current	$ \begin{array}{l} \mbox{pin } \overline{\mbox{OE}}, \ S; \ V_{I} = V_{CC} - 0.6 \ V; \\ V_{SW} = GND \ or \ V_{CC}; \\ V_{CC} = 3.6 \ V \end{array} $	-	-	300	-	2000	μA
CI	input capacitance	pin \overline{OE} , S; V _{CC} = 3.3 V; V _I = 0 V to 3.3 V	-	0.9	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance	$V_{CC} = 3.3 \text{ V}; V_1 = 0 \text{ V to } 3.3 \text{ V}$	-	5.2	-	-	-	pF
C _{S(ON)}	ON-state capacitance	$V_{CC} = 3.3 \text{ V}; V_{I} = 0 \text{ V to } 3.3 \text{ V}$	-	14.3	-	-	-	pF

[1] All typical values are measured at T_{amb} = 25 °C.

[2] One input at 3 V, other inputs at V_{CC} or GND.

9.1 Test circuits



Quad 1-of-2 multiplexer/demultiplexer

9.2 ON resistance

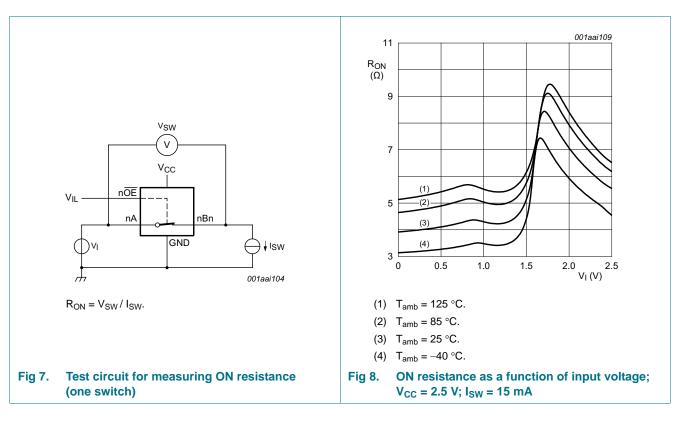
Table 7. Resistance R_{ON}

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 7.

Symbol	Parameter	Conditions	T _{amb} = ·	–40 °C to	+85 °C	T _{amb} = -40 °	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
R _{ON}	ON resistance	V _{CC} = 2.3 V to 2.7 V; [2] see <u>Figure 8</u> to <u>Figure 10</u>						
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		I _{SW} = 15 mA; V _I = 1.7 V	-	8.4	40.0	-	60.0	Ω
		$V_{CC} = 3.0 V$ to 3.6 V; see <u>Figure 11</u> to <u>Figure 13</u>						
		I _{SW} = 64 mA; V _I = 0 V	-	4.0	7.0	-	11.0	Ω
		$I_{SW} = 24 \text{ mA}; V_{I} = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		I_{SW} = 15 mA; V _I = 2.4 V	-	6.2	15.0	-	25.5	Ω

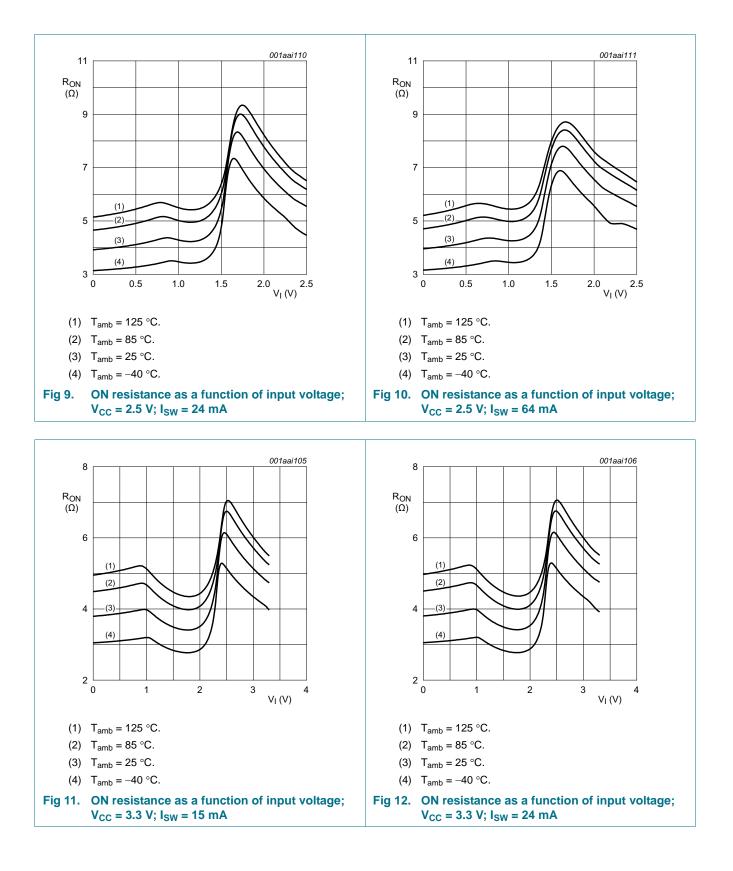
[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$ and nominal V_{CC} .

[2] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.



9.3 ON resistance test circuit and graphs

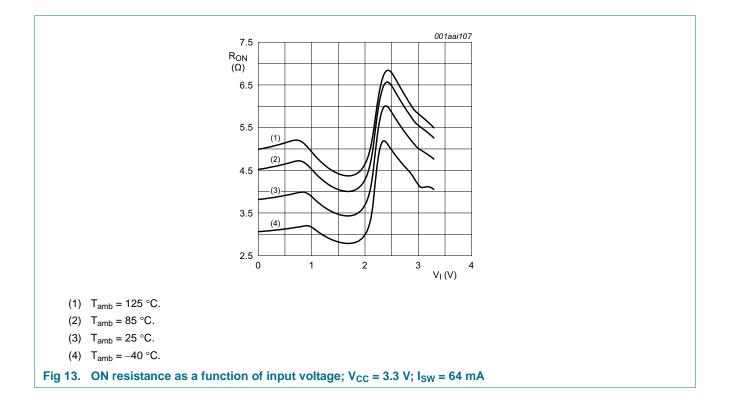
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10. Dynamic characteristics

Table 8. Dynamic characteristics

GND = 0 V; for test circuit see <u>Figure 16</u>

Symbol	Parameter	Conditions		T _{amb} =	–40 °C to	+85 °C	$T_{amb} = -40$ °	Unit	
				Min	Typ <mark>[1]</mark>	Max	Min	Max	-
t _{pd}	propagation delay	nA to nBn or nBn to nA; see <u>Figure 14</u>	[2][3]						
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	-	0.15	-	0.25	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	-	0.15	-	0.25	ns
		S to nA; see Figure 14	[3]						
		V_{CC} = 2.3 V to 2.7 V		1.0	3.8	6.1	1.0	6.7	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.2	5.3	1.0	5.8	ns
t _{en}	enable time	OE to nA or nBn; see <u>Figure 15</u>	<u>[4]</u>						
		V_{CC} = 2.3 V to 2.7 V		1.0	2.2	5.6	1.0	6.2	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.0	5.0	1.0	5.5	ns
		S to nBn; see Figure 15							
		V_{CC} = 2.3 V to 2.7 V		1.0	3.5	6.1	1.0	6.7	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.0	5.3	1.0	5.8	ns
t _{dis}	disable time	OE to nA or nBn; see Figure 15	[5]						
		V_{CC} = 2.3 V to 2.7 V		1.0	2.6	5.5	1.0	6.1	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.1	5.5	1.0	6.1	ns
		S to nBn; see Figure 15							
		V_{CC} = 2.3 V to 2.7 V		1.0	2.6	4.8	1.0	5.3	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	3.2	4.5	1.0	5.0	ns

[1] All typical values are measured at $T_{amb} = 25 \text{ °C}$ and at nominal V_{CC} .

[2] The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

[3] t_{pd} is the same as t_{PLH} and t_{PHL} .

[4] t_{en} is the same as t_{PZH} and t_{PZL} .

 $\label{eq:tdis} [5] \quad t_{dis} \mbox{ is the same as } t_{PHZ} \mbox{ and } t_{PLZ}.$

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11. Waveforms

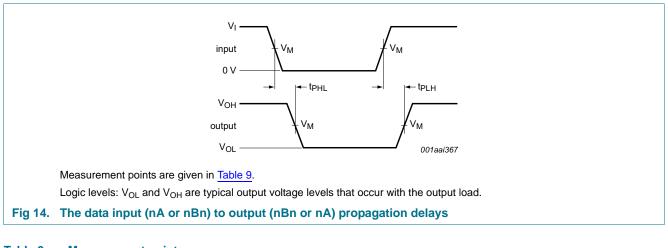
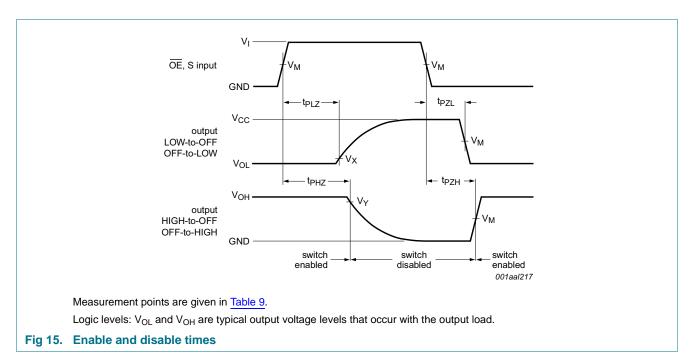


Table 9.Measurement points

Supply voltage	Input			Output		
V _{cc}	V _M	VI	$t_r = t_f$	V _M	V _X	V _Y
2.3 V to 2.7 V	0.5V _{CC}	V _{CC}	≤ 2.0 ns	0.5V _{CC}	V _{OL} + 0.15 V	V _{OH} – 0.15 V
3.0 V to 3.6 V	0.5V _{CC}	V _{CC}	≤ 2.0 ns	0.5V _{CC}	V _{OL} + 0.3 V	V _{OH} – 0.3 V



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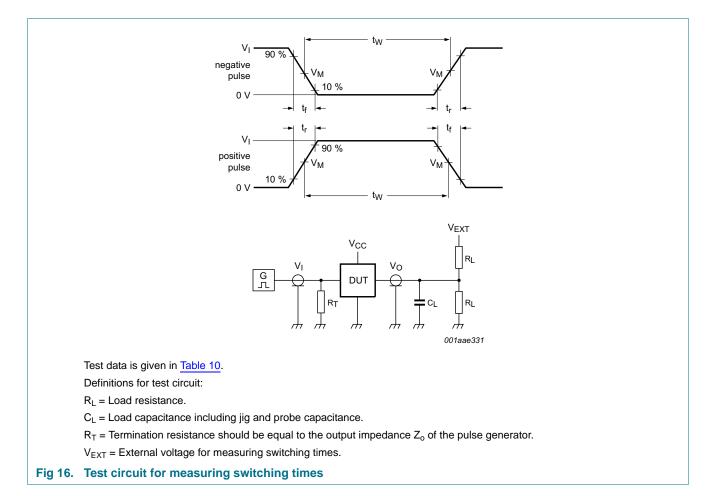


Table 10. Test data

Supply voltage	Load		V _{EXT}				
V _{cc}	CL	RL	t _{PLH} , t _{PHL}	t _{PZL} , t _{PLZ}			
2.3 V to 2.7 V	30 pF	500 Ω	open	GND	2V _{CC}		
3.0 V to 3.6 V	50 pF	500 Ω	open	GND	2V _{CC}		

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11.1 Additional dynamic characteristics

Table 11. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns.

Symbol	Parameter	Conditions	T _{amb} = 25 °C		Unit	
			Min	Тур	Мах	
f _(-3dB)	–3 dB frequency response	$V_{CC} = 3.3 \text{ V}; \text{ R}_{L} = 50 \Omega; \text{ see } \frac{\text{Figure 17}}{11}$	-	398	-	MHz

[1] f_i is biased at 0.5V_{CC}.

11.2 Test circuits

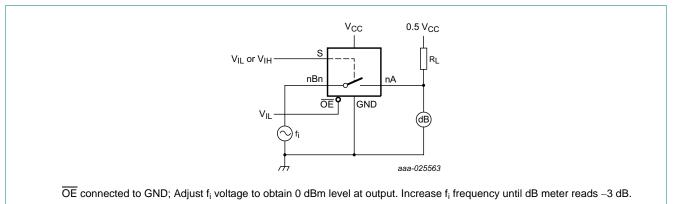


Fig 17. Test circuit for measuring the frequency response when channel is in ON-state

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12. Package outline

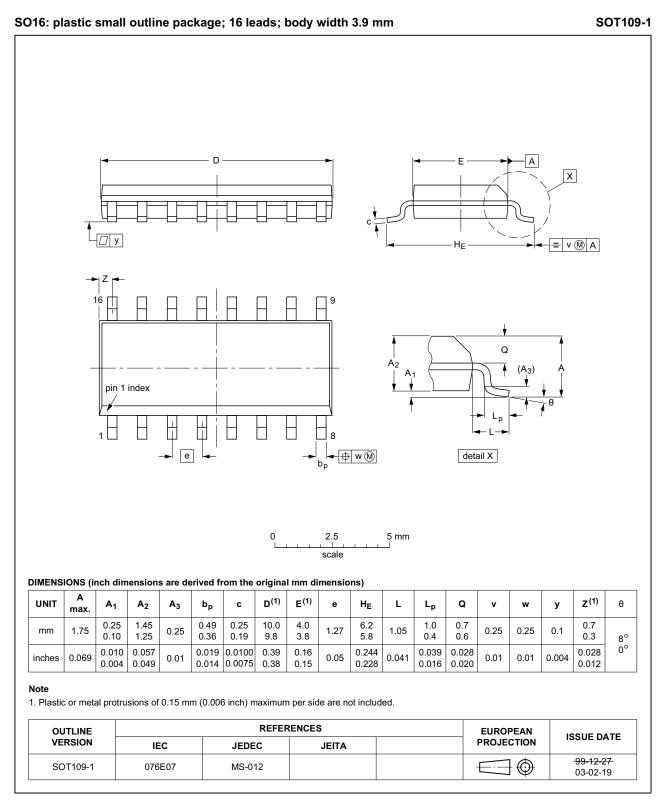
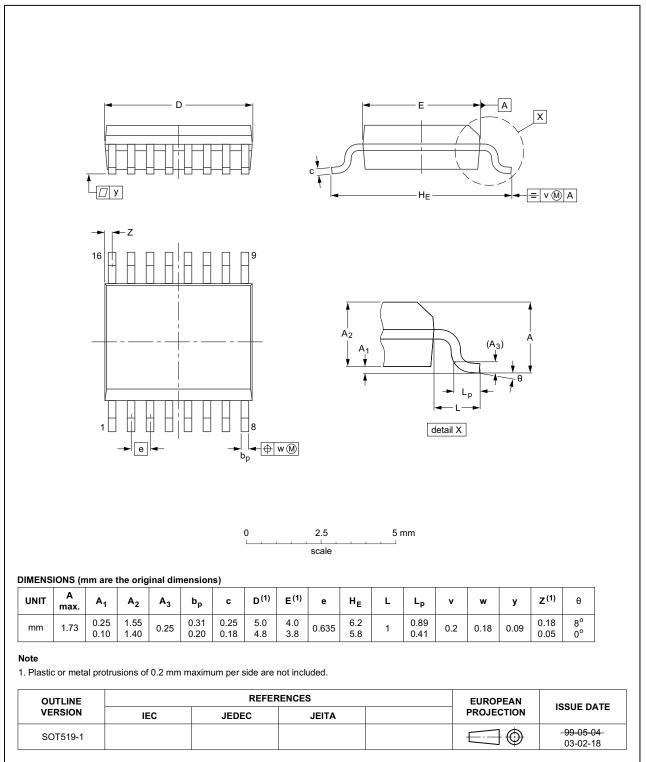


Fig 18. Package outline SOT109-1 (SO16)

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SSOP16: plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm SOT519-1

Fig 19. Package outline SOT519-1 (SSOP16)

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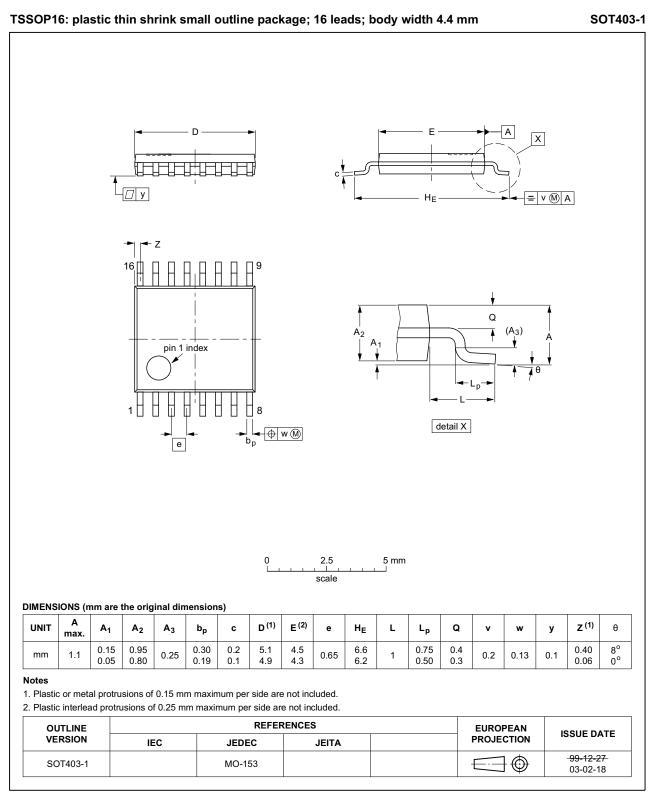
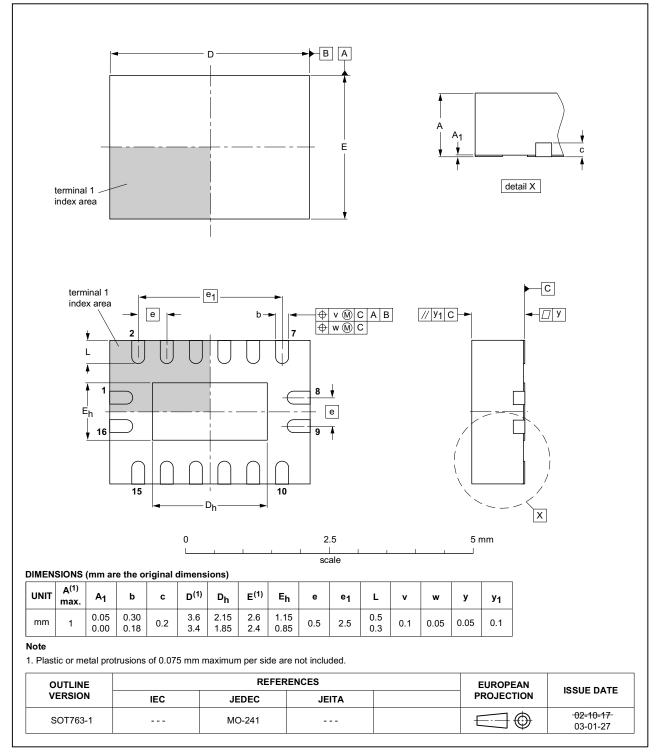


Fig 20. Package outline SOT403-1 (TSSOP16)

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

Fig 21. Package outline SOT763-1 (DHVQFN16)

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Quad 1-of-2 multiplexer/demultiplexer

13. Abbreviations

Table 12. Abbreviati	ons
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
ММ	Machine Model

14. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74CBTLV3257 v.5	20161111	Product data sheet	-	74CBTLV3257 v.4
Modifications:	Section 11	.1 and Section 11.2 added.		·
74CBTLV3257 v.4	20111216	Product data sheet	-	74CBTLV3257 v.3
Modifications:	 Legal page 	es updated.	<u>.</u>	
74CBTLV3257 v.3	20110106	Product data sheet	-	74CBTLV3257 v.2
74CBTLV3257 v.2	20101126	Product data sheet	-	74CBTLV3257 v.1
74CBTLV3257 v.1	20100112	Product data sheet	-	-

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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16. Contact information

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Quad 1-of-2 multiplexer/demultiplexer

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Date of release: 11 November 2016 Document identifier: 74CBTLV3257

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